74AUP1Z125

Low-power X-tal driver with enable and internal resistor; 3-state

Rev. 5 — 8 August 2012

Product data sheet

1. General description

The 74AUP1Z125 combines the functions of the 74AUP1GU04 and 74AUP1G125 with enable circuitry and an internal bias resistor to provide a device optimized for use in crystal oscillator applications.

When not in use the \overline{EN} input can be driven HIGH, pulling up the $\underline{X1}$ input and putting the device in a low-power disable mode. Schmitt trigger action at the \overline{EN} input makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF} at output Y. The I_{OFF} circuitry disables the output Y, preventing the damaging backflow current through the device when it is powered down.

The integration of the two devices into the 74AUP1Z125 produces the benefits of a compact footprint, lower power dissipation and stable operation over a wide range of frequency and temperature.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114F Class 3A exceeds 5000 V
 - ♦ MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD78B Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial power-down mode operation at output Y
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



Low-power X-tal driver with enable and internal resistor; 3-state

3. Ordering information

Table 1. Ordering information

Type number	Package						
	Temperature range	Name	Description	Version			
74AUP1Z125GW	–40 °C to +125 °C	SC-88	plastic surface-mounted package; 6 leads	SOT363			
74AUP1Z125GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886			
74AUP1Z125GF	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm	SOT891			
74AUP1Z125GN	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115			
74AUP1Z125GS	–40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 \times 1.0 \times 0.35 mm	SOT1202			

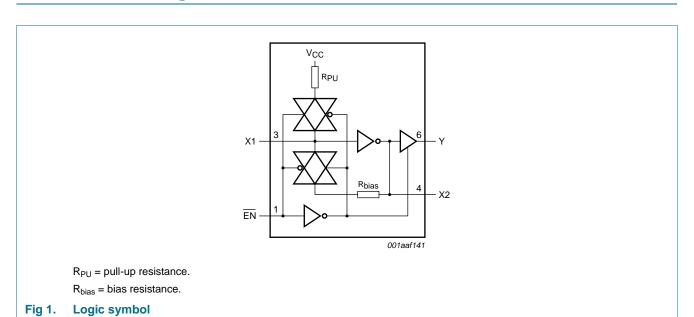
4. Marking

Table 2. Marking

Type number	Marking code ^[1]
74AUP1Z125GW	55
74AUP1Z125GM	55
74AUP1Z125GF	55
74AUP1Z125GN	55
74AUP1Z125GS	55

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram



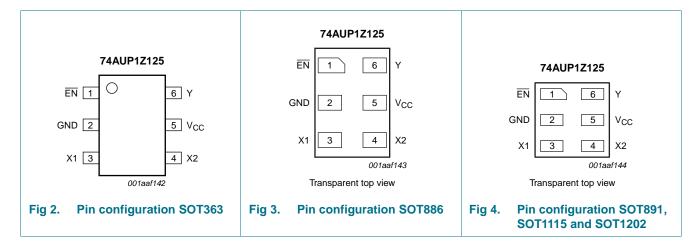
74AUP1Z125

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Low-power X-tal driver with enable and internal resistor; 3-state

6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

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Symbol	Pin	Description
EN	1	enable input (active LOW)
GND	2	ground (0 V)
X1	3	data input
X2	4	unbuffered output
V _{CC}	5	supply voltage
Υ	6	data output

7. Functional description

Table 4. Function table[1]

Input X1		Output		
EN	X1	X2	Υ	
L	L	Н	Н	
L	Н	L	L	
Н	L	Н	Z	
Н	Н	L	Z	

^[1] H = HIGH voltage level;

L = LOW voltage level;

Z = high-impedance OFF-state.

Low-power X-tal driver with enable and internal resistor; 3-state

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		[<u>1</u>] -0.5	+4.6	V
I _{OK}	output clamping current	V _O < 0 V	-50	-	mA
Vo	output voltage	Active mode and Power-down mode	<u>[1]</u> –0.5	+4.6	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±20	mA
I _{CC}	supply current		-	50	mA
I_{GND}	ground current		-50	-	mA
T_{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	[2] -	250	mW

^[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		8.0	3.6	V
V_{I}	input voltage		0	3.6	V
Vo	output voltage		0	V_{CC}	V
T _{amb}	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 0.8 V to 3.6 V	-	200	ns/V

^[2] For SC-88 packages: above 87.5 $^{\circ}$ C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 packages: above 118 $^{\circ}$ C the value of P_{tot} derates linearly with 7.8 mW/K.

Low-power X-tal driver with enable and internal resistor; 3-state

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = 2	5 °C					
V _{IH}	HIGH-level input voltage	X1 input				
		$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		EN input				
		$V_{CC} = 0.8 \text{ V}$	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
V_{IL}	LOW-level input voltage	X1 input				
		$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	$0.25 \times V_{CC}$	V
		EN input				
		$V_{CC} = 0.8 \text{ V}$	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	V
V _{OH}	HIGH-level output voltage	Y output; V_I at X1 input = V_{IH} or V_{IL}				
		$I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_O = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.72	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V
		X2 output; $V_I = GND$ or V_{CC}				
		$I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	V _{CC} – 0.1	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.11	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.32	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	2.05	-	-	V
		$I_O = -3.1 \text{ mA}$; $V_{CC} = 2.3 \text{ V}$	1.9	-	-	٧
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.72	-	-	V
		$I_O = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.6	-	-	V

Table 7. Static characteristicscontinued

At recommended operating conditions: voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Uni
√oL	LOW-level output voltage	Y output; V_I at X1 input = V_{IH} or V_{IL}				
		I_O = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		$I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{\text{CC}}$	V
		$I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		$I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.31	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
		X2 output; $V_I = GND$ or V_{CC}				
		$I_O = 20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	0.1	V
		$I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.31	V
		$I_O = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.31	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.31	V
		$I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.44	V
		$I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.31	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.44	V
l ₁	input leakage current	X1 input				
		$V_I = \overline{EN} = V_{CC}$; $V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.1	μΑ
		EN input				
		$V_I = GND \text{ to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.1	μΑ
pu	pull-up current	X1 input; $\overline{EN} = V_{CC}$				
		$V_{I} = GND; V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	15	μΑ
loz	OFF-state output current	Y output; $V_{\underline{O}} = 0 \text{ V to } 3.6 \text{ V}; V_{\underline{CC}} = 0 \text{ V to } 3.6 \text{ V}; EN = V_{\underline{CC}}$	-	-	±0.1	μΑ
OFF	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	[1] -	-	±0.2	μΑ
ΔI_{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	[1] -	-	±0.2	μΑ
CC	supply current	$V_1 = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	75	μΑ
∆l _{CC}	additional supply current	EN input				
		$V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	-	-	40	μΑ
C _I	input capacitance	X1 input				
•		$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND or } V_{CC}$	-	1.3	-	pF
		EN input				
		$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND or } V_{CC}$	-	0.8	-	pF

Table 7. Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Co	output capacitance	X2 output				
		$V_O = GND; V_{CC} = 0 V$	-	1.5	-	pF
		Y output				
		$V_O = GND; V_{CC} = 0 V$	-	1.7	-	pF
g _{fs}	forward transconductance	see Figure 10 and Figure 11				
		V _{CC} = 0.8 V	-	-	-	mA/V
		V _{CC} = 1.1 V to 1.3 V	0.2	-	9.9	mA/V
		V _{CC} = 1.4 V to 1.6 V	3.9	-	17.7	mA/V
		V _{CC} = 1.65 V to 1.95 V	7.9	-	24.3	mA/V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	18	-	30.7	mA/V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	20.5	-	32.4	mA/V
R _{bias}	bias resistance	\overline{EN} = GND; f _i = 0 Hz; V _I = 0 V or V _{CC} ; See <u>Figure 5</u> ; for frequency behavior see <u>Figure 6</u>	1.08	1.62	3.08	ΜΩ
T _{amb} = -	40 °C to +85 °C					
V_{IH}	HIGH-level input voltage	X1 input				
		$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		EN input				
		V _{CC} = 0.8 V	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	$0.65 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
V_{IL}	LOW-level input voltage	X1 input				
		$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	$0.25 \times V_{CC}$	V
		EN input				
		$V_{CC} = 0.8 \text{ V}$	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	-	-	$0.35 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	V

Table 7. Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{OH}	HIGH-level output voltage	Y output; V_I at X1 input = V_{IH} or V_{IL}				
		$I_O = -20~\mu\text{A};~V_{CC} = 0.8~V$ to 3.6 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.7 \times V_{CC}$	-	-	V
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.03	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.30	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
		$X2$ output; $V_I = GND$ or V_{CC}				
	$I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V	$V_{CC} - 0.1$	-	-	V	
	$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.7 \times V_{CC}$	-	-	V	
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	1.03	-	-	V
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.30	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.97	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.85	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.67	-	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.55	-	-	V
/ _{OL}	LOW-level output voltage	Y output; V_I at X1 input = V_{IH} or V_{IL}				
		$I_O = 20 \ \mu A; \ V_{CC} = 0.8 \ V \ to \ 3.6 \ V$	-	-	0.1	V
		$I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.3 \times V_{CC}$	V
		$I_O = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.37	V
		$I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.35	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.45	V
		X2 output; $V_I = GND$ or V_{CC}				
		I_{O} = 20 μ A; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I _O = 1.1 mA; V _{CC} = 1.1 V	-	-	$0.3 \times V_{CC}$	V
		$I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.37	V
		$I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.35	V
		$I_O = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.33	V
		$I_O = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_O = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.33	V
		I_{O} = 4.0 mA; V_{CC} = 3.0 V	-	-	0.45	V

Table 7. Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
l _l	input leakage current	X1 input				
		$V_I = \overline{EN} = V_{CC}$; $V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.5	μΑ
		EN input				
		$V_I = GND \text{ to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.5	μА
I _{pu}	pull-up current	X1 input; $\overline{EN} = V_{CC}$				
		$V_I = GND$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V	-	-	15	μΑ
l _{OZ}	OFF-state output current	Y output; $V_{\underline{O}} = 0 \text{ V to } 3.6 \text{ V}; V_{CC} = 0$ V to 3.6 V; $\overline{EN} = V_{CC}$	-	-	±0.5	μА
I _{OFF}	power-off leakage current	V_I or $V_O = 0$ V to 3.6 V; $V_{CC} = 0$ V	<u>[1]</u> _	-	±0.5	μΑ
ΔI_{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	[1] -	-	±0.6	μА
I _{CC}	supply current	$V_I = GND \text{ or } V_{CC}; I_O = 0 \text{ A};$ $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	75	μА
ΔI_{CC}	additional supply current	EN input				
		$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	-	-	50	μА
g _{fs}	forward transconductance	see Figure 10 and Figure 11				
		V _{CC} = 0.8 V	-	-	-	mA/V
		V _{CC} = 1.1 V to 1.3 V	-	-	10.8	mA/V
		V _{CC} = 1.4 V to 1.6 V	1.8	-	21.2	mA/V
		V _{CC} = 1.65 V to 1.95 V	7.5	-	29.9	mA/V
		V _{CC} = 2.3 V to 2.7 V	15.0	-	38.0	mA/V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	17.8	-	39.2	mA/V
R _{bias}	bias resistance	\overline{EN} = GND; f _i = 0 Hz; V _I = 0 V or V _{CC} ; See <u>Figure 5</u> ; for frequency behavior see <u>Figure 6</u>	1.07	-	3.11	ΜΩ

Table 7. Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{amb} = -	40 °C to +125 °C					
V _{IH}	HIGH-level input voltage	X1 input				
		$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		EN input				
		$V_{CC} = 0.8 \text{ V}$	$0.75 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	-	-	V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	V
V _{IL}	LOW-level input voltage	X1 input				
		$V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	$0.25 \times V_{CC}$	٧
		EN input				
		V _{CC} = 0.8 V	-	-	$0.25 \times V_{CC}$	٧
		$V_{CC} = 0.9 \text{ V to } 1.95 \text{ V}$	-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	٧
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	-	-	0.9	٧
√он	HIGH-level output voltage	Y output; V_I at X1 input = V_{IH} or V_{IL}				
		$I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.11	-	-	٧
		$I_{O} = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.6 \times V_{CC}$	-	-	٧
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	٧
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.17	-	-	٧
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	٧
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	٧
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	٧
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.30	-	-	V
		X2 output; $V_I = GND$ or V_{CC}				
		$I_{O} = -20 \mu A$; $V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	V _{CC} - 0.11	-	-	٧
		$I_O = -1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	$0.6 \times V_{CC}$	-	-	٧
		$I_{O} = -1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	0.93	-	-	٧
		$I_{O} = -1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.17	-	-	V
		$I_{O} = -2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.77	-	-	V
		$I_{O} = -3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.67	-	-	V
		$I_{O} = -2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.40	-	-	V
		$I_O = -4.0 \text{ mA}$; $V_{CC} = 3.0 \text{ V}$	2.30	-	-	V

Table 7. Static characteristics ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{OL}	LOW-level output voltage	Y output; $V_I = V_{IH}$ or V_{IL}				
		$I_O = 20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V	-	-	0.11	V
		$I_O = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.33 \times V_{CC}$	V
		$I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.41	V
		$I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.39	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.36	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.50	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V
		X2 output; $V_I = GND$ or V_{CC}				
		$I_O = 20 \mu A$; $V_{CC} = 0.8 \text{ V}$ to 3.6 V	-	-	0.11	V
		$I_{O} = 1.1 \text{ mA}; V_{CC} = 1.1 \text{ V}$	-	-	$0.33 \times V_{CC}$	V
		$I_{O} = 1.7 \text{ mA}; V_{CC} = 1.4 \text{ V}$	-	-	0.41	V
		$I_{O} = 1.9 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.39	V
		$I_{O} = 2.3 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.36	V
		$I_{O} = 3.1 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.50	V
		$I_{O} = 2.7 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.36	V
		$I_{O} = 4.0 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.50	V
I	input leakage current	X1 input				
		$V_I = \overline{EN} = V_{CC}$; $V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.75	μΑ
		EN input				
		$V_I = GND \text{ to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V to } 3.6 \text{ V}$	-	-	±0.75	μΑ
pu	pull-up current	X1 input; $\overline{EN} = V_{CC}$				
		$V_{I} = GND; V_{CC} = 0.8 \text{ V to } 3.6 \text{ V}$	-	-	15	μΑ
OZ	OFF-state output current	Y output; $V_{\underline{O}} = 0$ V to 3.6 V; $V_{CC} = 0$ V to 3.6 V; $\overline{EN} = V_{CC}$	-	-	±0.75	μΑ
OFF	power-off leakage current	V_{I} or $V_{O} = 0 \text{ V}$ to 3.6 V; $V_{CC} = 0 \text{ V}$	[1] _	-	±0.75	μΑ
VI _{OFF}	additional power-off leakage current	V_1 or $V_0 = 0$ V to 3.6 V; $V_{CC} = 0$ V to 0.2 V	[1] -	-	±0.75	μΑ
СС	supply current	V_I = GND or V_{CC} ; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	75	μΑ
VI _{CC}	additional supply current	EN input				
		$V_I = V_{CC} - 0.6 \text{ V}; I_O = 0 \text{ A};$ $V_{CC} = 3.3 \text{ V}$	-	-	75	μΑ

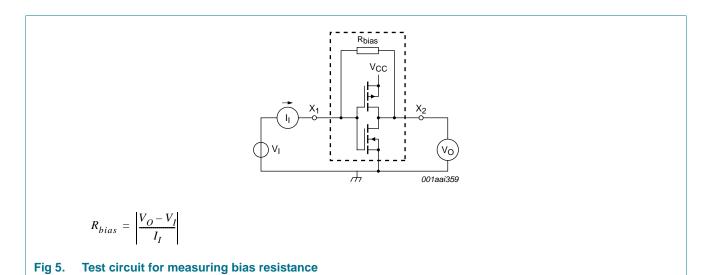
Low-power X-tal driver with enable and internal resistor; 3-state

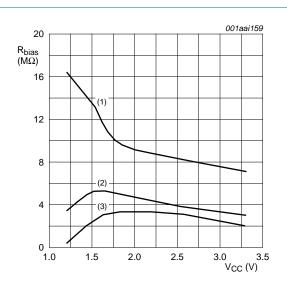
 Table 7.
 Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
g _{fs}	forward transconductance	see Figure 10 and Figure 11				
		$V_{CC} = 0.8 \text{ V}$	-	-	-	mA/V
		V _{CC} = 1.1 V to 1.3 V	-	-	10.8	mA/V
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	1.8	-	21.2	mA/V
		V _{CC} = 1.65 V to 1.95 V	6.9	-	29.9	mA/V
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	13.4	-	38.0	mA/V
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	15.8	-	39.2	mA/V
R _{bias}	bias resistance	$\overline{\text{EN}}$ = GND; f _i = 0 Hz; V _I = 0 V or V _{CC} ; See <u>Figure 5</u> ; for frequency behavior see <u>Figure 6</u>	1.07	-	3.11	ΜΩ

[1] Only for output Y and input \overline{EN} .





- (1) $f_i = 30 \text{ kHz}.$
- (2) $f_i = 1 \text{ MHz}.$
- (3) $f_i = 10 \text{ MHz}.$

Fig 6. Typical bias resistance versus supply voltage

Low-power X-tal driver with enable and internal resistor; 3-state

11. Dynamic characteristics

Table 8. Dynamic characteristics

Symbol	Parameter	Conditions		25 °C		-40	0 °C to +1	25 °C	Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
$C_L = 5 pl$	F		'	'			'		'
t_{pd}	propagation delay	X1 to X2; see Figure 7	l						
		$V_{CC} = 0.8 \text{ V}$	-	6.2	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	0.9	2.3	4.4	0.9	4.8	5.3	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	0.7	1.7	3.1	0.6	3.4	3.8	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	0.5	1.4	2.6	0.5	2.9	3.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	0.4	1.1	2.0	0.4	2.3	2.6	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0.3	1.0	1.8	0.3	2.1	2.4	ns
		X1 to Y; see Figure 7	<u>l</u>						
		$V_{CC} = 0.8 \text{ V}$	-	18.5	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	2.8	5.9	12.5	3.2	14.8	16.3	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	2.2	4.2	7.7	2.6	9.1	10.1	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.9	3.5	6.2	2.2	7.8	8.6	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.6	2.9	4.8	1.9	6.2	6.9	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.4	2.6	4.1	1.7	4.7	5.2	ns
t _{en}	enable time	EN to Y; see Figure 8	<u>l</u>						
		$V_{CC} = 0.8 \text{ V}$	-	31.2	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	3.1	6.1	13.8	2.9	16.3	18.0	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	2.5	4.3	8.2	2.3	9.7	10.7	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2.1	3.6	6.5	2.0	7.6	8.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.8	2.9	4.8	1.7	5.8	6.4	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.7	2.6	4.1	1.7	4.7	5.2	ns
t _{dis}	disable time	EN to Y; see Figure 8]						
		V _{CC} = 0.8 V	-	11.1	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	2.5	4.5	9.0	2.9	9.4	10.4	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	2.0	3.3	6.4	2.3	6.7	7.4	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	1.9	3.2	6.0	2.0	6.4	7.1	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.4	2.3	4.4	1.7	4.7	5.2	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	1.7	2.6	4.4	1.7	4.9	5.4	ns

Low-power X-tal driver with enable and internal resistor; 3-state

 Table 8.
 Dynamic characteristics ...continued

Symbol	Parameter	Conditions			25 °C		-40) °C to +1	25 °C	Unit
				Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 10 p	o F								'	'
t _{pd}	propagation delay	X1 to X2; see Figure 7	[2]							
		$V_{CC} = 0.8 \text{ V}$		-	9.6	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		1.2	3.1	6.1	1.2	6.8	7.5	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		1.0	2.3	4.0	0.9	4.6	5.1	ns
		V_{CC} = 1.65 V to 1.95 V		8.0	1.9	3.3	0.7	3.8	4.2	ns
		V_{CC} = 2.3 V to 2.7 V		0.6	1.5	2.7	0.6	3.1	3.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		0.5	1.3	2.4	0.5	2.7	3.0	ns
		X1 to Y; see Figure 7	[2]							
		V _{CC} = 0.8 V		-	21.4	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.2	6.7	14.3	3.6	16.2	17.9	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.1	4.9	8.9	3.0	10.1	11.2	ns
		V_{CC} = 1.65 V to 1.95 V		1.9	4.1	6.9	2.6	8.0	8.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.1	3.4	5.4	2.3	6.6	7.3	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.8	3.1	4.8	2.1	5.6	6.2	ns
t _{en}	enable time	EN to Y; see Figure 8	[3]							
		$V_{CC} = 0.8 \text{ V}$		-	34.4	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.6	6.9	15.5	3.4	16.0	17.6	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.3	5.0	9.3	2.2	9.6	10.6	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.0	4.2	7.2	1.9	7.9	8.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.8	3.4	5.5	1.7	6.4	7.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.7	3.2	4.9	1.7	5.5	6.1	ns
t _{dis}	disable time	EN to Y; see Figure 8	[4]							
		$V_{CC} = 0.8 \text{ V}$		-	13.0	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		3.4	5.7	10.4	3.4	10.8	11.9	ns
		V _{CC} = 1.4 V to 1.6 V		2.1	4.2	7.6	2.2	8.0	8.8	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.2	4.3	7.3	1.9	7.6	8.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.6	3.1	5.3	1.7	5.5	6.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.1	3.8	6.0	1.7	6.5	7.2	ns

Low-power X-tal driver with enable and internal resistor; 3-state

Table 8. Dynamic characteristics ...continued

Symbol	Parameter	Conditions			25 °C		-40	°C to +1	25 °C	Unit
			N	Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 15	o F	'	ľ					'		
t _{pd}	propagation delay	X1 to X2; see Figure 7	2]							
		$V_{CC} = 0.8 \text{ V}$		-	13.0	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		1.6	3.8	7.9	1.4	8.8	9.7	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		1.3	2.8	4.9	1.1	5.7	6.3	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.0	2.3	4.0	0.9	4.7	5.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	(8.0	1.9	3.2	0.8	3.7	4.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	(0.7	1.6	2.9	0.7	3.3	3.7	ns
		X1 to Y; see Figure 7	2]							
		V _{CC} = 0.8 V		-	24.2	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$;	3.6	7.5	16.1	4.0	17.6	19.4	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$;	3.0	5.4	9.7	3.3	10.6	11.7	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2	2.2	4.6	7.7	2.9	9.0	9.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2	2.0	3.9	6.1	2.6	7.3	8.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2	2.0	3.6	5.4	2.3	5.9	6.5	ns
t _{en}	enable time	EN to Y; see Figure 8	3]							
		$V_{CC} = 0.8 \text{ V}$		-	37.5	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$	4	4.0	7.7	17.2	3.7	17.5	19.3	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$;	3.0	5.5	10.0	2.5	10.2	11.3	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	2	2.3	4.7	7.9	2.1	9.2	10.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	2	2.0	3.9	6.2	2.0	7.4	8.2	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2	2.0	3.6	5.5	1.9	6.0	6.6	ns
t _{dis}	disable time	EN to Y; see Figure 8	<u>4]</u>							
		$V_{CC} = 0.8 \text{ V}$		-	14.8	-	-	-	-	ns
		V _{CC} = 1.1 V to 1.3 V	4	4.3	6.8	11.2	3.7	12.4	13.7	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$;	3.0	5.1	8.1	2.5	8.9	9.8	ns
		V_{CC} = 1.65 V to 1.95 V	;	3.0	5.4	8.0	2.1	9.3	10.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$:	2.1	3.9	6.1	2.0	7.3	8.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2	2.9	5.1	7.2	1.9	7.9	8.7	ns

Low-power X-tal driver with enable and internal resistor; 3-state

Table 8. Dynamic characteristics ...continued

Symbol	Parameter	Conditions			25 °C		-40	0 °C to +1	25 °C	Unit
				Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C _L = 30	F									
t _{pd}	propagation delay	X1 to X2; see Figure 7	[2]							
		$V_{CC} = 0.8 \text{ V}$		-	23.2	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		2.4	6.0	13.1	2.2	14.8	16.3	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		2.0	4.2	7.6	1.8	9.0	9.9	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.7	3.6	6.1	1.5	7.2	8.0	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.4	2.9	4.8	1.3	5.7	6.3	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.2	2.5	4.3	1.1	5.1	5.7	ns
		X1 to Y; see Figure 7	[2]							
		$V_{CC} = 0.8 \text{ V}$		-	32.6	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		4.8	9.6	21.0	5.0	21.7	23.9	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		4.0	6.9	12.4	4.3	13.5	14.9	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.9	5.9	9.8	3.8	10.7	11.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.7	5.0	7.5	3.3	8.2	9.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.7	4.7	6.8	3.1	7.7	8.5	ns
t _{en}	enable time	EN to Y; see Figure 8	[3]							
		$V_{CC} = 0.8 \text{ V}$		-	47.1	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		5.2	9.9	21.0	4.8	21.7	23.9	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		4.0	7.1	12.4	3.1	13.5	14.9	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		3.0	6.0	9.9	2.8	10.7	11.8	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.7	5.0	7.7	2.6	8.1	9.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.7	4.8	6.8	2.6	7.7	8.5	ns
t _{dis}	disable time	EN to Y; see Figure 8	[4]							
		$V_{CC} = 0.8 \text{ V}$		-	20.3	-	-	-	-	ns
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		6.0	10.2	15.3	4.8	16.5	18.2	ns
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		4.4	7.8	11.2	3.1	12.3	13.6	ns
		V_{CC} = 1.65 V to 1.95 V		5.1	8.8	12.5	2.8	13.3	14.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		3.6	6.3	8.6	2.6	9.5	10.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		5.2	8.8	11.5	2.6	13.0	14.3	ns

Low-power X-tal driver with enable and internal resistor; 3-state

 Table 8.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 9.

Symbol	Parameter	r Conditions			25 °C		-40	°C to +1	25 °C	Unit
			N		Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
$C_L = 5 pF$	C _L = 5 pF, 10 pF, 15 pF and 30 pF									
	power dissipation capacitance	$f_i = 1 \text{ MHz}; \overline{EN} = GND;$ $V_I = GND \text{ to } V_{CC}$	[5][6]							
		$V_{CC} = 0.8 \text{ V}$		-	7.1	-	-	-	-	pF
		$V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$		-	12.9	-	-	-	-	pF
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$		-	19.2	-	-	-	-	pF
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		-	19.9	-	-	-	-	pF
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	21.6	-	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	24.3	-	-	-	-	pF

- [1] All typical values are measured at nominal V_{CC} .
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] t_{en} is the same as t_{PZH} and t_{PZL} .
- [4] t_{dis} is the same as t_{PHZ} and t_{PLZ} .
- [5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

 f_i = input frequency in MHz;

 f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

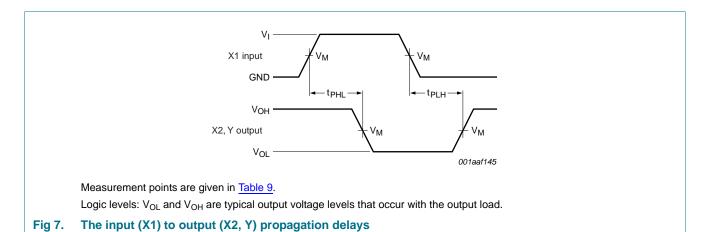
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

[6] Feedback current is included in C_{PD}.

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12. Waveforms



Measurement points

Table 9.

Supply voltage	Output	Input		
V _{CC}	V _M	V _M	VI	$t_r = t_f$
0.8 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{CC}	≤ 3.0 ns

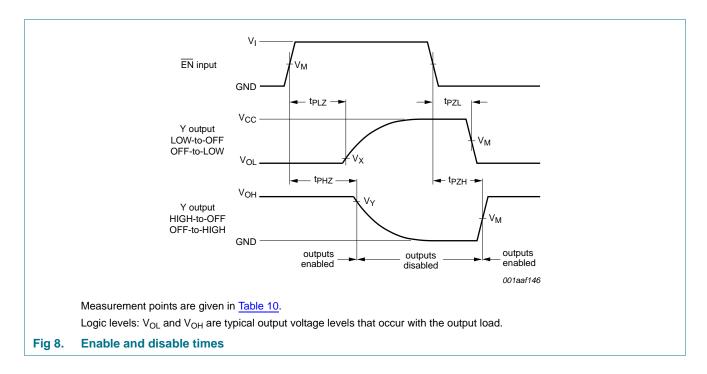
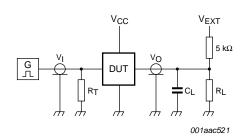


Table 10. Measurement points

Supply voltage	Input	Output	Output						
V _{CC}	V _M	V _M	V _X	V _Y					
0.8 V to 1.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{\text{CC}}$	V _{OL} + 0.1 V	$V_{OH} - 0.1 V$					
1.65 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.15 V	$V_{OH} - 0.15 V$					
3.0 V to 3.6 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	V _{OL} + 0.3 V	$V_{OH}-0.3\ V$					

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Test data is given in Table 11.

Definitions for test circuit:

R_L = Load resistance.

 C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

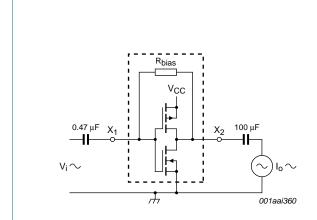
V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

Table 11. Test data

Supply voltage	Load	V _{EXT}			
V _{CC}	CL	R _L [1]	t _{PLH} , t _{PHL}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 k Ω or 1 M Ω	open	GND	$2 \times V_{CC}$

[1] For measuring enable and disable times R_L = 5 $k\Omega$, for measuring propagation delays, setup and hold times and pulse width R_L = 1 $M\Omega$.

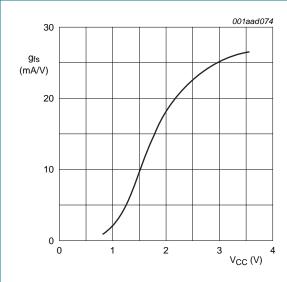




 $f_i = 1 \text{ kHz}.$

Vo is constant.

Fig 10. Test set-up for measuring forward transconductance



 T_{amb} = 25 °C.

Fig 11. Typical forward transconductance as a function of supply voltage

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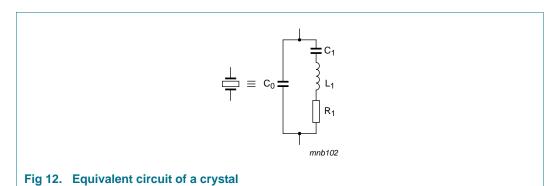
13. Application information

Crystal controlled oscillator circuits are widely used in clock pulse generators because of their excellent frequency stability and wide operating frequency range. The use of the 74AUP1Z125 provides the additional advantages of low power dissipation, stable operation over a wide range of frequency and temperature and a very small footprint. This application information describes crystal characteristics, design and testing of crystal oscillator circuits based on the 74AUP1Z125.

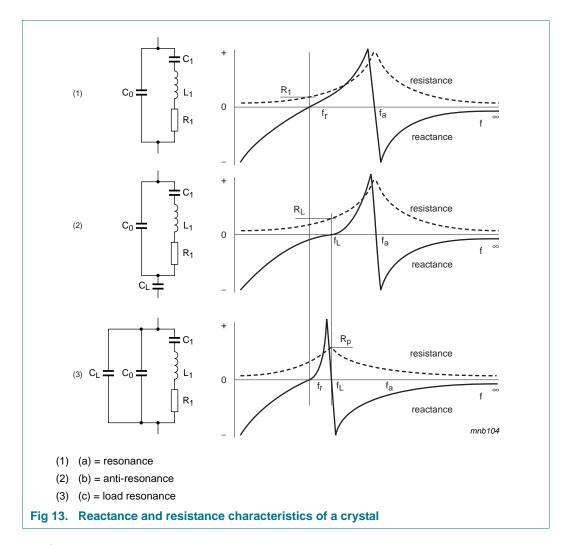
13.1 Crystal characteristics

Figure 12 is the equivalent circuit of a quartz crystal.

The reactive and resistive components of the impedance of the crystal alone, and the crystal with a series and a parallel capacitance, is shown in Figure 13.



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13.1.1 **Design**

Figure 14 shows the recommended way to connect a crystal to the 74AUP1Z125. This circuit is basically a Pierce oscillator circuit in which the crystal is operating at its fundamental frequency and tuned by the parallel load capacitance of C_1 and C_2 . C_1 and C_2 are in series with the crystal. They should be approximately equal. R_1 is the drive-limiting resistor and is set to approximately the same value as the reactance of C_1 at the crystal frequency ($R_1 = X_{C1}$). This results in an input to the crystal of 50 % of the rail-to-rail output of X2. This keeps the drive level into the crystal within drive specifications (the designer should verify this). Overdriving the crystal can cause damage.

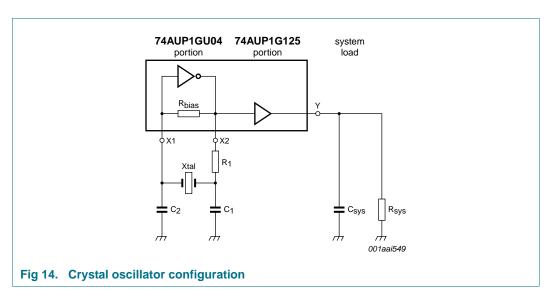
The internal bias resistor provides negative feedback and sets a bias point of the inverter near mid-supply, operating the 74AUP1GU04 in the high gain linear region.

To calculate the values of C₁ and C₂, the designer can use the formula:

$$C_L = \frac{C_1 \times C_2}{C_1 + C_2} + C_s$$

 C_L is the load capacitance as specified by the crystal manufacturer. C_s is the stray capacitance of the circuit and for 74AUP1Z125, C_s is equal to an input capacitance of 1.5 pF.

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13.1.2 Testing

After the calculations are performed for a particular crystal, the oscillator circuit should be tested. The following simple checks verify the prototype design of a crystal controlled oscillator circuit. Perform the checks after laying out the board:

- Test the oscillator over worst-case conditions (lowest supply voltage, worst-case crystal and highest operating temperature). Adding series and parallel resistors can simulate a worse case crystal.
- Insure that the circuit does not oscillate without the crystal.
- Check the frequency stability over a supply range greater than that which is likely to occur during normal operation.
- Check that the start-up time is within system requirements.

As the 74AUP1Z125 isolates the system loading, once the design is optimized, the single layout may work in multiple applications for any given crystal.

14. Package outline

Plastic surface-mounted package; 6 leads

SOT363

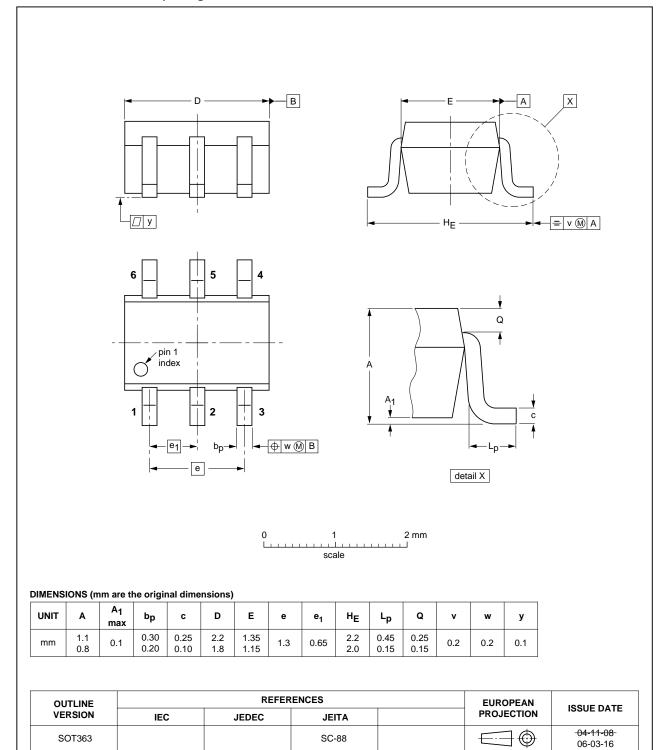


Fig 15. Package outline SOT363 (SC-88)

74AUP1Z125

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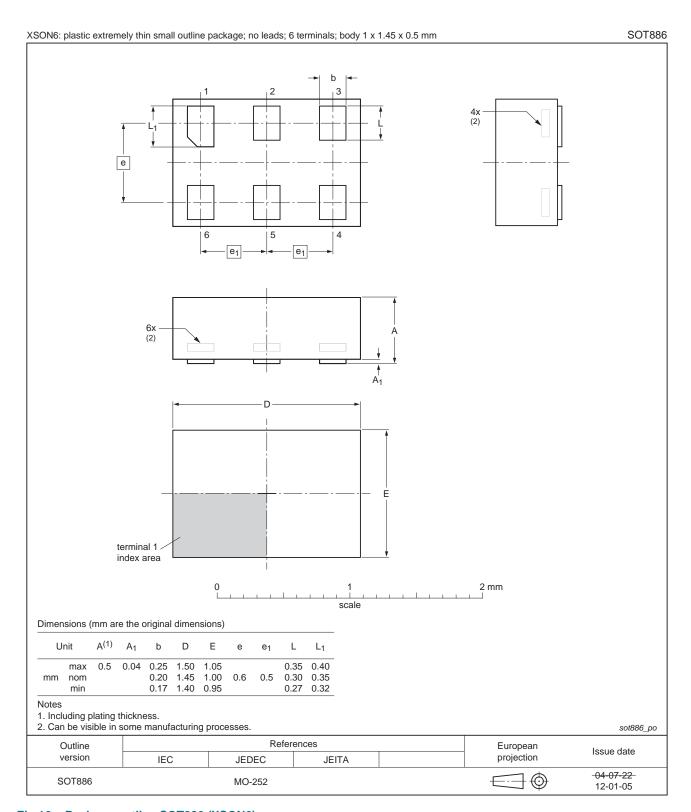


Fig 16. Package outline SOT886 (XSON6)

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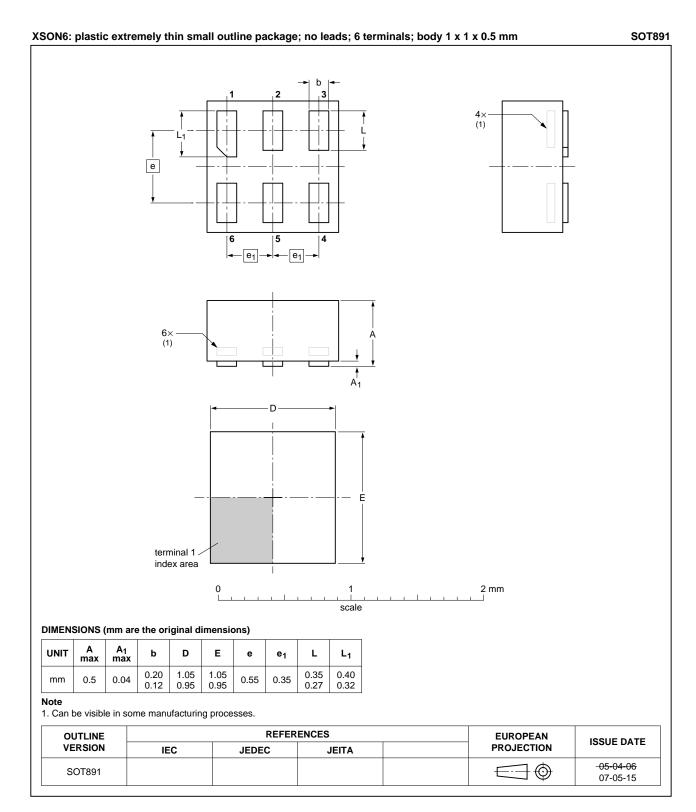


Fig 17. Package outline SOT891 (XSON6)

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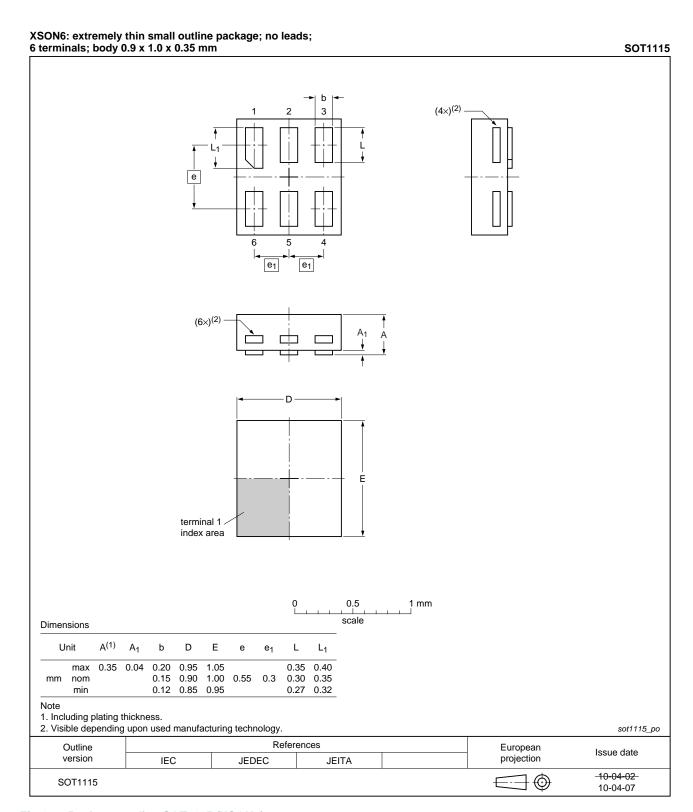


Fig 18. Package outline SOT1115 (XSON6)

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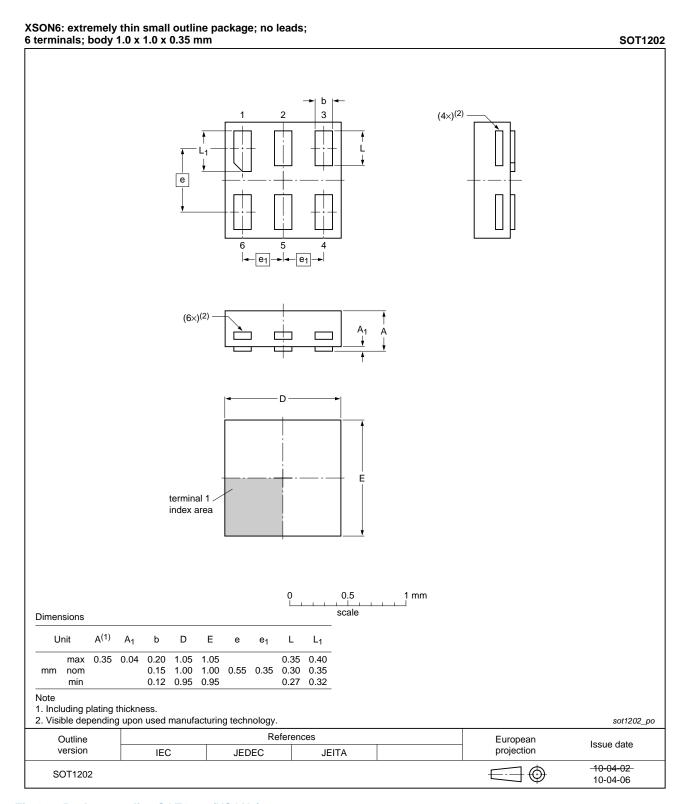


Fig 19. Package outline SOT1202 (XSON6)

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15. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model

16. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1Z125 v.5	20120808	Product data sheet	-	74AUP1Z125 v.4
Modifications:	 Package outl 	ine drawing of SOT886 (<u>Figu</u>	re 16) modified.	
74AUP1Z125 v.4	20111201	Product data sheet	-	74AUP1Z125 v.3
Modifications:	 Legal pages 	updated.		
74AUP1Z125 v.3	20100909	Product data sheet	-	74AUP1Z125 v.2
74AUP1Z125 v.2	20080807	Product data sheet	-	74AUP1Z125 v.1
74AUP1Z125 v.1	20060803	Product data sheet	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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19. Contents

1	General description	. 1
2	Features and benefits	. 1
3	Ordering information	. 2
4	Marking	. 2
5	Functional diagram	. 2
6	Pinning information	. 3
6.1	Pinning	. 3
6.2	Pin description	. 3
7	Functional description	. 3
8	Limiting values	. 4
9	Recommended operating conditions	. 4
10	Static characteristics	. 5
11	Dynamic characteristics	14
12	Waveforms	19
13	Application information	21
13.1	Crystal characteristics	21
13.1.1	Design	
13.1.2	Testing	
14	Package outline	24
15	Abbreviations	29
16	Revision history	29
17	Legal information	30
17.1	Data sheet status	30
17.2	Definitions	
17.3	Disclaimers	
17.4	Trademarks	_
18	Contact information	
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